μECoG Array with 3,072 Electrodes for High-Density and Large-Area Cortical Recordings Based on Scalable Thin-Film Electronics

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Introduction: Large-scale neural implants, involving hundreds of electrodes and spanning multiple cortical areas, are emerging in clinics and neuroscience laboratories [1][2], however their accessibility remains limited. These technologies are based on cutting-edge flexible materials and rely on advanced integrated circuits for their acquisition, and therefore are only produced in research environments at high costs. We propose a novel system, including an industrially manufactured multi-thousand channel μ ECoG implant, and a commercially available acquisition tool, resulting in a full neural implant solution, easily integrated in any laboratory environment.

Material, Methods and Results: Our µECoG can simultaneously record neural signals in the 1-200 Hz ECoG bandwidth, with 3,072 multiplexed electrodes. The embedded metal-oxide thin-film transistors

used to switch between electrodes have previously been established by our group [3], and are now being manufactured in an industrial foundry. Moreover, we have shown their biocompatibility according to ISO standards [3]. Their new low-cost and rapid production yields scaled devices, optimized for high conformability to the brain tissue with an 18 μ m thick polyimide substrate. High resolution and very high-density is achieved through iridium electrodes with 200 μ m pitch and customizable size between

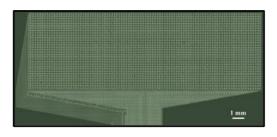


Figure 1: Micrograph of the 3,072 electrode $\mu ECoG$ implant with $100 \times 100 \mu m^2$ iridium electrodes and 200 μm electrode pitch.

30*30 and $100*100 \ \mu\text{m}^2$. We have developed a small headstage and flexible connectors which enable a smooth implantation of the devices. Interfacing printed circuit boards (PCBs) were designed to achieve a compact system connecting to a carefully selected standard acquisition tool for electrophysiology laboratories. Demultiplexing of the signals is performed in near real-time enabling monitoring of the signals during recordings. In-vivo experiments have shown the capability of the implant to delineate whisker movements in the somatosensory cortex of rodents and has revealed dynamics across several cortical areas.

Conclusion: The accessible μ ECoG system developed in this work yields unparalleled high-density recordings over large areas of the cortex. Thanks to its industrial production, the number of electrodes could be drastically increased compared to state-of-the-art implants and enables the rapid and low-cost manufacturing of the devices. Multi-thousand channel implants thus become easily accessible and can help push the boundaries of neuroprostheses.

References:

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